

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Lopatin et al.
Title: METHOD OF USING AN ADHESION PRECURSOR LAYER FOR
CHEMICAL VAPOR DEPOSITION (CVD) COPPER DEPOSITION
Appl. No.: 10/687,186
Filing Date: 10/16/2003
Examiner: Thanh T. Nguyen
Art Unit: 2813
Conf. No.: 7567

ISSUE FEE TRANSMITTAL

Mail Stop Issue Fee
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Enclosed herewith please find Issue Fee Transmittal Form PTOL-85(B).

Fees in the amount of \$1,700.00 for payment of the Issue Fee and the Publication Fee are being paid by credit card via EFS-Web.

The Commissioner is hereby authorized to charge any additional fees which may be required regarding this application under 37 C.F.R. §§ 1.16-1.17, or credit any overpayment, to Deposit Account No. 06-1447. Should no proper payment be enclosed herewith, as by the credit card payment instructions in EFS-Web being incorrect or absent, resulting in a rejected or incorrect credit card transaction, the Commissioner is authorized to charge the unpaid amount to Deposit Account No. 06-1447.

Respectfully submitted,

Date

12-19-2006

By



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